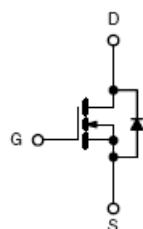


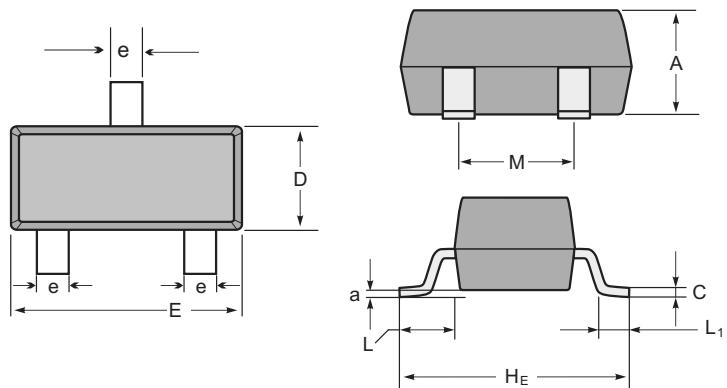
**FEATURE**

- High density cell design for low  $R_{DS(ON)}$
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability

**SOT-23**

**Equivalent Circuit**

**Marking**

Type number	Marking code
SI2302	A2SHB


**SOT-23 mechanical data**

	UNIT	A	C	D	E	H <sub>E</sub>	e	M	L	L <sub>1</sub>	a
mm	max	1.1	0.15	1.4	3.0	2.6	0.5	1.95	0.55 (ref)	0.36 (ref)	0.0
	min	0.9	0.08	1.2	2.8	2.2	0.3	1.7			0.15
mil	max	43	6	55	118	102	20	77	22 (ref)	14 (ref)	0.0
	min	35	3	47	110	87	12	67			6

**Maximum ratings ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Value		Unit
Drain-Source Voltage	$V_{DS}$	20	$\pm 12$	V
Gate-Source Voltage	$V_{GS}$			
Continuous Drain Current	$I_D$	4.3	0.6	A
Continuous Source-Drain Current(Diode Conduction)	$I_S$			
Power Dissipation	$P_D$	1.2	357	W
Thermal Resistance from Junction to Ambient ( $t \leq 5\text{s}$ )	$R_{\theta JA}$			
Operating Junction	$T_J$	150	-55 ~ +150	°C
Storage Temperature	$T_{STG}$			

# SI2302

## Electrical characteristics ( $T_a=25^\circ\text{C}$ unless otherwise noted)

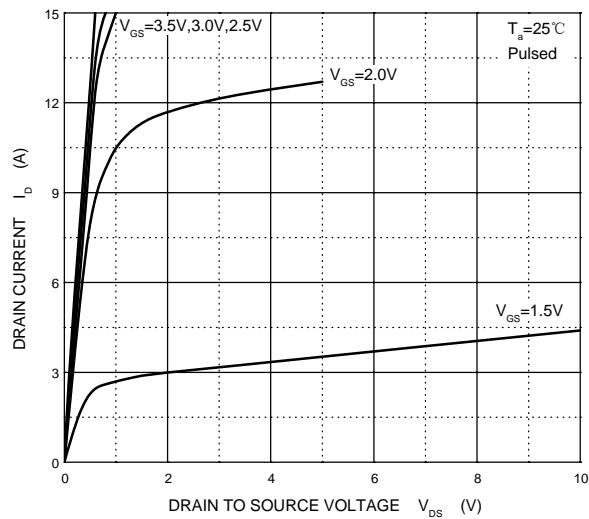
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Static</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 10\mu\text{A}$	20	22		V
Gate-threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.5	0.7	1.1	
Gate-body leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 8\text{V}$			$\pm 100$	nA
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Drain-source on-resistance <sup>a</sup>	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 4.0\text{A}$		25	40	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5\text{V}, I_D = 3.0\text{A}$		35	50	
Forward transconductance <sup>a</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 5\text{V}, I_D = 3.6\text{A}$		8		S
Diode forward voltage	$V_{\text{SD}}$	$I_S = 0.94\text{A}, V_{\text{GS}} = 0\text{V}$		0.76	1.2	V
<b>Dynamic</b>						
Total gate charge	$Q_g$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 3.6\text{A}$		4.0	10	nC
Gate-source charge	$Q_{\text{gs}}$			0.65		
Gate-drain charge	$Q_{\text{gd}}$			1.5		
Input capacitance <sup>b</sup>	$C_{\text{iss}}$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		300		pF
Output capacitance <sup>b</sup>	$C_{\text{oss}}$			120		
Reverse transfer capacitance <sup>b</sup>	$C_{\text{rss}}$			80		
<b>Switching<sup>b</sup></b>						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 10\text{V}, R_L = 5.5\Omega, I_D \approx 3.6\text{A}, V_{\text{GEN}} = 4.5\text{V}, R_g = 6\Omega$		7	15	ns
Rise time	$t_r$			55	80	
Turn-off delay time	$t_{\text{d}(\text{off})}$			16	60	
Fall time	$t_f$			10	25	

### Notes :

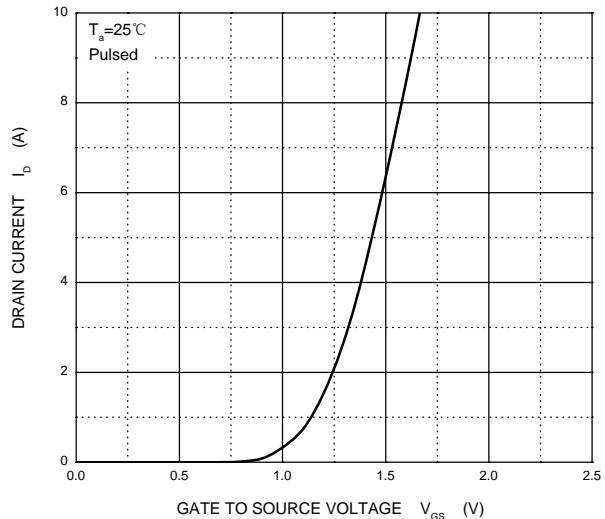
- a. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. These parameters have no way to verify.

## RATING AND CHARACTERISTIC CURVES (SI2302)

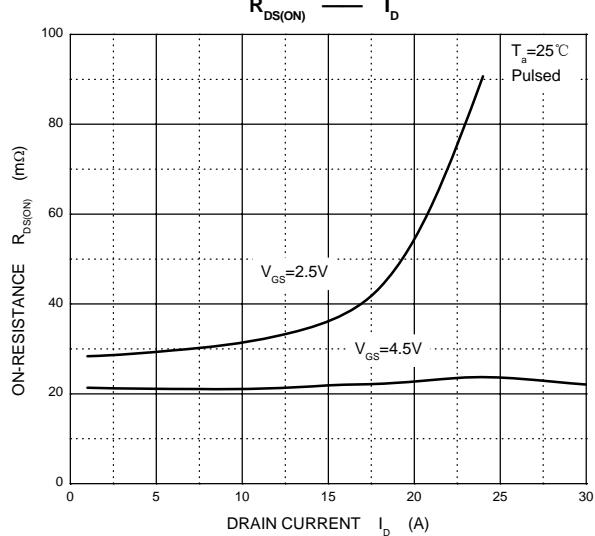
**Output Characteristics**



**Transfer Characteristics**



$R_{DS(ON)}$  —  $I_D$



$R_{DS(ON)}$  —  $V_{GS}$

